

Jun. 23. 2005 7:43PM

RECEIVED  
CENTRAL FAX CENTER  
JUN 23 2005

No. 0261 P. 1/12

Atty. Docket No. CPAC 1014-4  
Appl. No. 10/608,843

PATENT

IN THE UNITED STATES PATENT AND TRADEMARK OFFICE

Applicant: Taekun LEE *et al.*

)  
) Examiner: Khiem D. Nguyen

Application No.: 10/608,843

)  
) Group Art Unit: 2823

Filed: June 27, 2003

)  
) Date: June 23, 2005

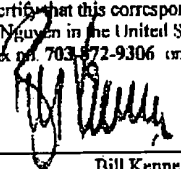
Title: (Amended) Method for manufacturing  
plastic ball grid array with integral  
heatsink

)  
)  
)

CERTIFICATE OF FACSIMILE TRANSMISSION

I hereby certify that this correspondence is being facsimile transmitted to  
Examiner Nguyen in the United States Patent and Trademark Office, at the  
Central Fax no. 703-672-9306 on June 23, 2005.

Signed

  
Bill Kennedy

COMMISSIONER FOR PATENTS  
P.O. Box 1450  
ALEXANDRIA, VA 22313-1450

AMENDMENT

Dear Sir:

In response to the Advisory Action mailed 22 June 2005, kindly amend the application as follows.

Amendments to the Specification begin on page 2 of this paper.

Amendments to the Claims are reflected in the Listing of Claims which begins on page 3 of this paper.

Remarks begin on page 5 of this paper.

RECEIVED  
OIPE/IAP

JUN 27 2005